

1. SCOPE

1.1 Scope. This drawing documents the general requirements of a high performance quadruple 2-input positive AND gate microcircuit, with an operating temperature range of -40°C to +125°C.

1.2 Vendor Item Drawing Administrative Control Number. The manufacturer's PIN is the item of identification. The vendor item drawing establishes an administrative control number for identifying the item on the engineering documentation:

<u>V62/04704</u>	-	<u>01</u>	<u>X</u>	<u>E</u>
Drawing number		Device type (See 1.2.1)	Case outline (See 1.2.2)	Lead finish (See 1.2.3)

1.2.1 Device type(s).

<u>Device type</u>	<u>Generic</u>	<u>Circuit function</u>
01	CD74HC08-EP	Quadruple 2-input positive AND gate

1.2.2 Case outlines. The case outlines are as specified herein.

<u>Outline letter</u>	<u>Number of pins</u>	<u>JEDEC PUB 95</u>	<u>Package style</u>
X	14	MS-012	Plastic small-outline

1.2.3 Lead finishes. The lead finishes are as specified below or other lead finishes as provided by the device manufacturer:

<u>Finish designator</u>	<u>Material</u>
A	Hot solder dip
B	Tin-lead plate
C	Gold plate
D	Palladium
E	Gold flash palladium
Z	Other

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/04704
		REV B	PAGE 2

1.3 Absolute maximum ratings. 1/

Supply voltage range (V_{CC})	-0.5 V to +7 V
Input clamp current (I_{IK}) ($V_I < -0.5$ V or $V_I > V_{CC} + 0.5$ V)	± 20 mA 2/
Output clamp current (I_{OK}) ($V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V)	± 20 mA 2/
Continuous output current (I_O) ($V_O > -0.5$ V or $V_O < V_{CC} + 0.5$ V)	± 25 mA
Continuous current through V_{CC} or GND	± 50 mA
Package thermal impedance (θ_{JA})	180°C/W 3/
Maximum junction temperature (T_J)	150°C
Lead temperature (during soldering):	
At distance 1/16 \pm 1/32 inch (1.59 \pm 0.79 mm) from case for 10 s max.	300°C
Storage temperature range (T_{STG})	-65°C to +150°C

1.4 Recommended operating conditions. 4/ 5/

Supply voltage range (V_{CC})	2 V to 6 V
Minimum high level input voltage (V_{IH}):	
$V_{CC} = 2$ V	1.5 V
$V_{CC} = 4.5$ V	3.15 V
$V_{CC} = 6$ V	4.2 V
Maximum low level input voltage (V_{IL}):	
$V_{CC} = 2$ V	0.5 V
$V_{CC} = 4.5$ V	1.35 V
$V_{CC} = 6$ V	1.8 V
Input voltage range (V_I)	0 V to V_{CC}
Output voltage range (V_O)	0 V to V_{CC}
Maximum input transition rise or fall rate ($\Delta t/\Delta v$):	
$V_{CC} = 2$ V	1000 ns
$V_{CC} = 4.5$ V	500 ns
$V_{CC} = 6$ V	400 ns
Operating free-air temperature range (T_A)	-40°C to +125°C

- 1/ Stresses beyond those listed under “absolute maximum rating” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- 2/ The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- 3/ The package thermal impedance is calculated in accordance with JESD 51-7.
- 4/ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.
- 5/ Use of this product beyond the manufacturers design rules or stated parameters is done at the user’s risk. The manufacturer and/or distributor maintain no responsibility or liability for product used beyond the stated limits.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/04704
		REV B	PAGE 3

2. APPLICABLE DOCUMENTS

JEDEC – SOLID STATE TECHNOLOGY ASSOCIATION (JEDEC)

- JEP95 – Registered and Standard Outlines for Semiconductor Devices
- JESD51-7 – High Effective Thermal Conductivity Test Board for Leaded Surface Mount Packages

(Copies of these documents are available online at <http://www.jedec.org> or from JEDEC – Solid State Technology Association, 3103 North 10th Street, Suite 240–S, Arlington, VA 22201-2107).

3. REQUIREMENTS

3.1 Marking. Parts shall be permanently and legibly marked with the manufacturer’s part number as shown in 6.3 herein and as follows:

- A. Manufacturer’s name, CAGE code, or logo
- B. Pin 1 identifier
- C. ESDS identification (optional)

3.2 Unit container. The unit container shall be marked with the manufacturer’s part number and with items A and C (if applicable) above.

3.3 Electrical characteristics. The maximum and recommended operating conditions and electrical performance characteristics are as specified in 1.3, 1.4, and table I herein.

3.4 Design, construction, and physical dimension. The design, construction, and physical dimensions are as specified herein.

3.5 Diagrams.

3.5.1 Case outline. The case outline shall be as shown in 1.2.2 and figure 1.

3.5.2 Truth table. The truth table shall be as shown in figure 2.

3.5.3 Logic diagram. The logic diagram shall be as shown in figure 3.

3.5.4 Terminal connections. The terminal connections shall be as shown in figure 4.

3.5.5 Timing waveforms and test circuit. The timing waveforms and test circuit shall be as shown in figure 5.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/04704
		REV B	PAGE 4

TABLE I. Electrical performance characteristics. 1/

Test	Symbol	Conditions	V _{CC}	Temperature, T _A	Device type	Limits		Unit
						Min	Max	
High level output voltage	V _{OH}	CMOS loads I _{OH} = -0.02 mA V _I = V _{IH} or V _{IL}	2 V	25°C, -40°C to 125°C	All	1.9		V
			4.5 V			4.4		
			6 V			5.9		
		TTL loads I _{OH} = -4 mA V _I = V _{IH} or V _{IL}	4.5 V	25°C		3.98		
				-40°C to 125°C		3.7		
			6 V	25°C		5.48		
		-40°C to 125°C	5.2					
Low level output voltage	V _{OL}	CMOS loads I _{OL} = 0.02 mA V _I = V _{IH} or V _{IL}	2 V	25°C, -40°C to 125°C	All		0.1	V
			4.5 V				0.1	
			6 V				0.1	
		TTL loads I _{OL} = 4 mA V _I = V _{IH} or V _{IL}	4.5 V	25°C			0.26	
				-40°C to 125°C			0.4	
			6 V	25°C			0.26	
		-40°C to 125°C		0.4				
Input current	I _I	V _I = V _{CC} or GND	6 V	25°C			±0.1	μA
				-55°C to 125°C			±1	
Quiescent supply current	I _{CC}	V _I = V _{CC} or GND I _O = 0 A	6 V	25°C			2	μA
				-55°C to 125°C			40	
Input capacitance	C _I			25°C, -40°C to 125°C			10	pF
Power dissipation capacitance per gate	C _{pd} 2/	No load.	5 V	25°C		37 TYP		pF

See footnotes at end of table.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/04704
		REV B	PAGE 5

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions	V _{CC}	Temperature, T _A	Device type	Limits		Unit		
						Min	Max			
Propagation delay time, A or B to Y	t _{pd}	C _L = 50 pF See figure 5	2 V	25°C	All		90	ns		
				-55°C to 125°C			135			
			4.5 V	25°C			18			
				-55°C to 125°C			27			
			6 V	25°C			15			
				-55°C to 125°C			23			
			C _L = 15 pF See figure 5	5 V		25°C	7 TYP			
			Transition time, A or B to Y	t _t		C _L = 50 pF	2 V		25°C	
-55°C to 125°C		110								
4.5 V	25°C				15					
	-55°C to 125°C				22					
6 V	25°C				13					
	-55°C to 125°C				19					

1/ Testing and other quality control techniques are used to the extent deemed necessary to assure product performance over the specified temperature range. Product may not necessarily be tested across the full temperature range and all parameters may not necessarily be tested. In the absence of specific parametric testing, product performance is assured by characterization and/or design.

2/ C_{PD} is used to determine the dynamic power consumption, per gate.

$$P_D = V_{CC}^2 f_i (C_{PD} + C_L)$$

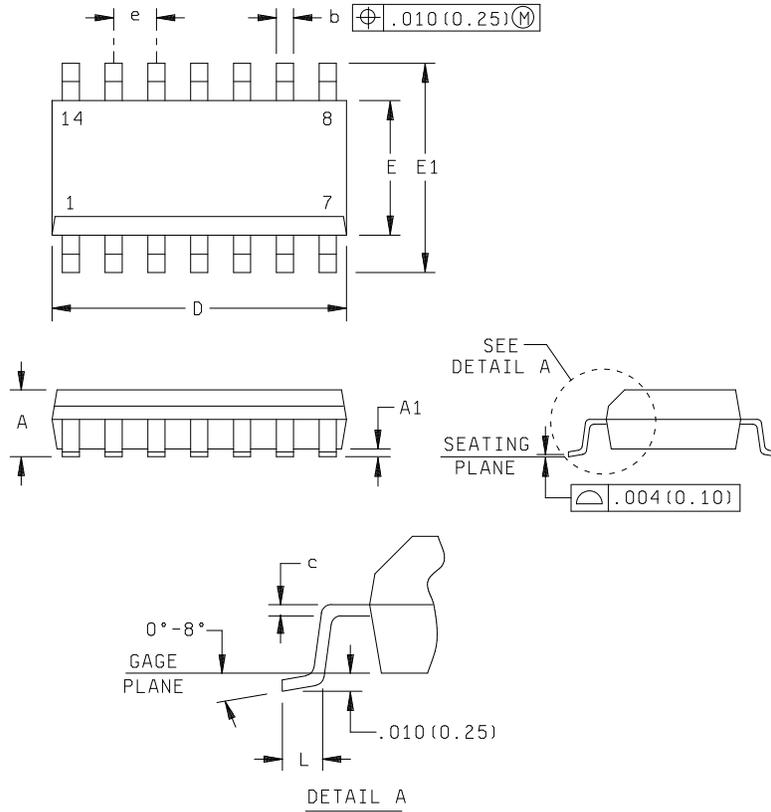
f_i = input frequency

C_L = output load capacitance

V_{CC} = supply voltage

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/04704
		REV B	PAGE 6

Case X



Dimensions									
Symbol	Inches		Millimeters		Symbol	Inches		Millimeters	
	Min	Max	Min	Max		Min	Max	Min	Max
A	---	.069	---	1.75	E	.150	.157	3.81	4.00
A1	.004	.010	0.10	0.25	E1	.228	.244	5.80	6.20
b	.014	.020	0.35	0.51	e	.050 BSC		1.27 BSC	
c	.008 NOM		0.20 NOM		L	.016	.044	0.40	1.12
D	.337	.344	8.55	8.75					

NOTES:

1. All linear dimensions are in inches (millimeters).
2. This case outline is subject to change without notice.
3. Body dimensions do not include mold flash or protrusion, not to exceed .006 inches (0.15 millimeters).
4. Fall within JEDEC MS-012.

FIGURE 1. Case outline.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/04704
		REV B	PAGE 7

(each gate)

Inputs		Output Y
A	B	
H	H	H
L	X	L
X	L	L

H = High voltage level
 L = Low voltage level
 X = Immaterial

FIGURE 2. Truth table.

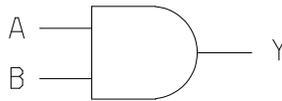
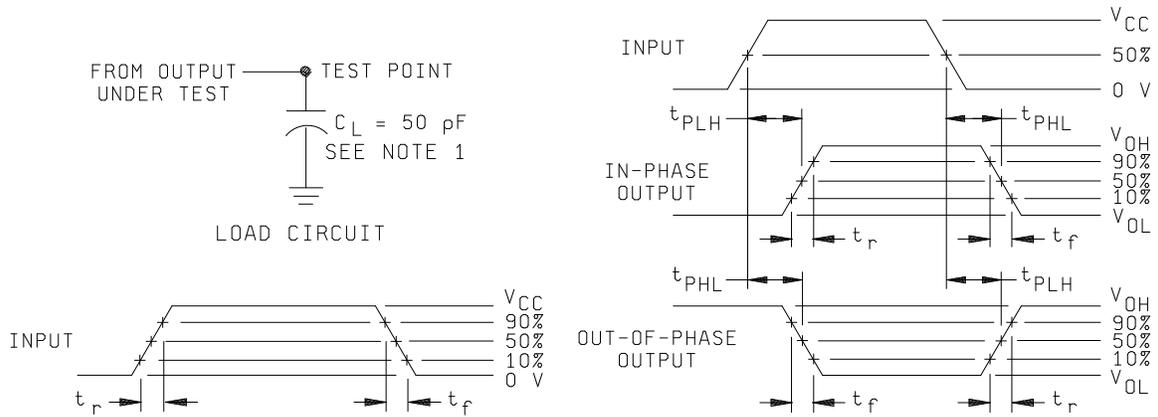


FIGURE 3. Logic diagram.

Device type		01	
Case outline		X	
Terminal number	Terminal symbol	Terminal number	Terminal symbol
1	1A	8	3Y
2	1B	9	3A
3	1Y	10	3B
4	2A	11	4Y
5	2B	12	4A
6	2Y	13	4B
7	GND	14	V _{CC}

FIGURE 4. Terminal connections.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/04704
		REV B	PAGE 8



Notes:

1. C_L includes probe and jig capacitance.
2. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1 \text{ MHz}$, $Z_o = 50\Omega$, $t_r = 6 \text{ ns}$, $t_f = 6 \text{ ns}$.
3. The outputs are measured one at a time with one input transition per measurement.
4. t_{PLH} and t_{PHL} are the same as t_{pd} .

FIGURE 5. Timing waveforms and test circuit.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/04704
		REV B	PAGE 9

4. VERIFICATION

4.1 Product assurance requirements. The manufacturer is responsible for performing all inspection and test requirements as indicated in their internal documentation. Such procedures should include proper handling of electrostatic sensitive devices, classification, packaging, and labeling of moisture sensitive devices, as applicable.

5. PREPARATION FOR DELIVERY

5.1 Packaging. Preservation, packaging, labeling, and marking shall be in accordance with the manufacturer's standard commercial practices for electrostatic discharge sensitive devices.

6. NOTES

6.1 ESDS. Devices are electrostatic discharge sensitive and are classified as ESDS class 1 minimum.

6.2 Configuration control. The data contained herein is based on the salient characteristics of the device manufacturer's data book. The device manufacturer reserves the right to make changes without notice. This drawing will be modified as changes are provided.

6.3 Suggested source(s) of supply. Identification of the suggested source(s) of supply herein is not to be construed as a guarantee of present or continued availability as a source of supply for the item. DLA Land and Maritime maintains an online database of all current sources of supply at <http://www.landandmaritime.dla.mil/Programs/Smcr/>.

Vendor item drawing administrative control number <u>1/</u>	Device manufacturer CAGE code	Vendor part number	Top-Side Marking
V62/04704-01XE	01295	CD74HC08QM96EP	HC08QEP

1/ The vendor item drawing establishes an administrative control number for identifying the item on the engineering documentation.

CAGE code

01295

Source of supply

Texas Instruments, Inc.
 Semiconductor Group
 8505 Forest lane
 P.O. Box 660199
 Dallas, TX 75243
 Point of contact: U.S. Highway 75 South
 P.O. Box 84, M/S 853
 Sherman, TX 75090-9493

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/04704
		REV B	PAGE 10